



PRODUCT SPECIFICATION

4.3" a-Si TFT LCD MODULE
MODEL: NTFT43S480272 Ver:1.5

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	4.3"	
LCD type	TN TFT	
Display Mode	Transmissive /Normally white	
Resolution	480 RGB x 272	Pixels
View Direction	12 O'clock	Best Image
Gray Scale Inversion Direction	6 O'clock	
Module Outline	105.5(H) x 67.2 (V) x 2.9(T) (Note1)	mm
Active Area	95.04(H) x 53.86(V)	mm
Pixel Pitch	198(H) x 198(V)	um
Pixel Arrangement	Stripe	
Polarizer Surface Treatment	Anti-Glare	
Display Colors	16M	
Interface	24-bit RGB interface	
Driver IC	OTA5180A	-
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	TBD	g

Note 1: Exclusive hooks, posts , FFC/FPC tail etc.

3. Absolute Maximum Ratings

$V_{SS}=0V, T_a=25^{\circ}C$

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VDD	-0.3	4.5	V
Storage temperature	T _{STG}	-30	+80	°C
Operating temperature	T _{OP}	-20	+70	°C

Note 1: If T_a below $50^{\circ}C$, the maximal humidity is 90%RH, if T_a over $50^{\circ}C$, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around $-10^{\circ}C$, and the back ground will become darker at high temperature operating.

4. DC Characteristics

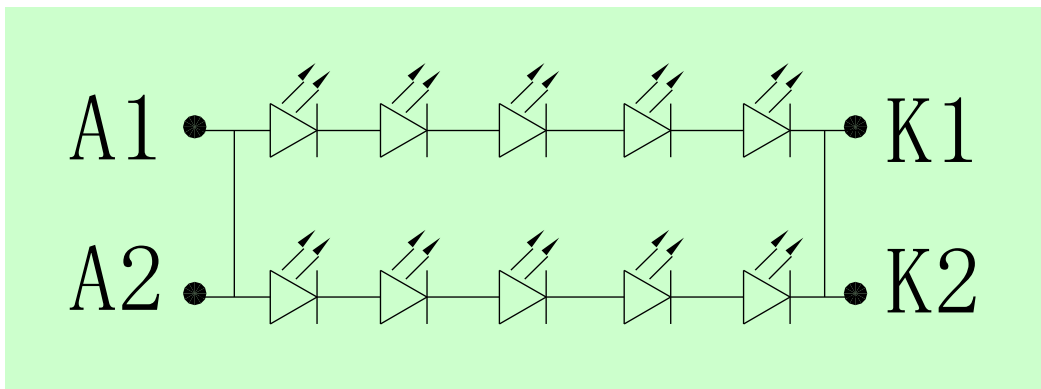
Item	Symbol	Min.	Typ.	Max.	Unit	
Digital Interface Supply Voltage	VDD	3.0	3.3	3.6	V	
Logic Low input voltage	V _{IL}	GND	-	0.3*VDD	V	
Logic High input voltage	V _{IH}	0.7*VDD	-	VDD	V	
Logic Low output voltage	V _{OL}	GND	-	GND+0.4	V	
Logic High output voltage	V _{OH}	VDD-0.4	-	VDD	V	
Current Consumption All Black	Logic Analog	I _{CC+} I _{IN}	-	TBD	-	mA

5. Backlight Characteristic

5.1. Backlight Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	T _a =25 °C, I _F =20mA/LED	15.5	16	16.5	V
Forward Current	I _F	T _a =25 °C, V _F =3.2V/LED	-	40	-	mA
Power dissipation	P _D		-	640	660	mW
Uniformity	Avg		-	80	-	%
Drive method	Constant current					
LED Configuration	10 White LEDs (5 LEDs in one string and 2 groups in parallel)					

5.2. Backlighting circuit



6. Optical Characteristics

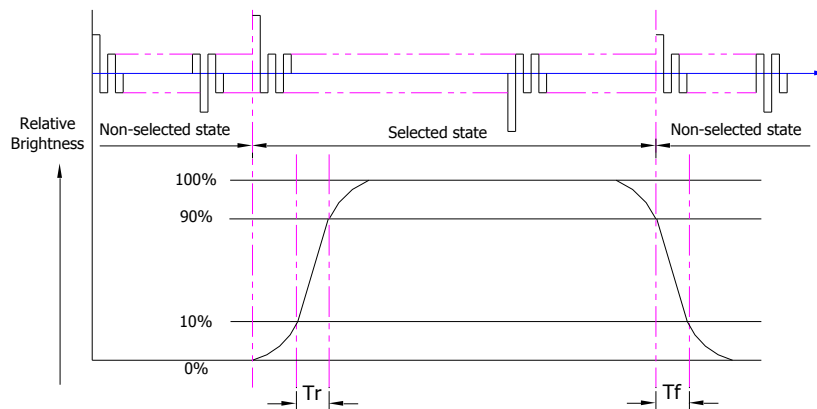
6.1. Optical Characteristics

Ta=25°C, V_{DD}=3.3V, TN LC+ Polarizer

	Item	Symbol	Condition	Specification			Unit	
				Min.	Typ.	Max.		
Backlight On (Transmissive Mode)	Luminance on TFT(I _f =20mA/LED)	Lv	Normally viewing angle θ _X = φ _Y = 0°	360	400	-	cd/m ²	
	Contrast ratio(See 6.3)	CR		250	350	-		
	Response time (See 6.2)	TR+TF		-	30	45	ms	
	Chromaticity Transmissive (See 6.5)	Red	X _R	Center CR≥10	0.534	0.584	0.634	
			Y _R		0.282	0.332	0.382	
		Green	X _G		0.275	0.325	0.375	
			Y _G		0.562	0.612	0.662	
		Blue	X _B		0.097	0.147	0.197	
			Y _B		0.065	0.115	0.165	
	White	X _W	0.236	0.286	0.336			
Y _W		0.265	0.315	0.365				
Viewing Angle (See 6.4)	Horizontal	θ _{X+}	Center CR≥10	-	60	-	Deg.	
		θ _{X-}		-	60	-		
	Vertical	φ _{Y+}		-	50	-		
		φ _{Y-}		-	55	-		
	NTSC Ratio(Gamut)			-	50	-	%	

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

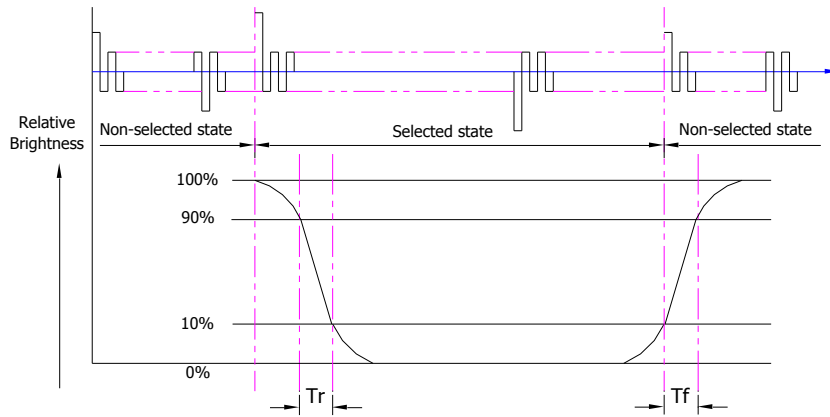


Tr is the time it takes to change from non-selected state with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note : Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change from non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note : Measuring machine: LCD-5100 or EQUI

6.3. Definition of Contrast Ratio

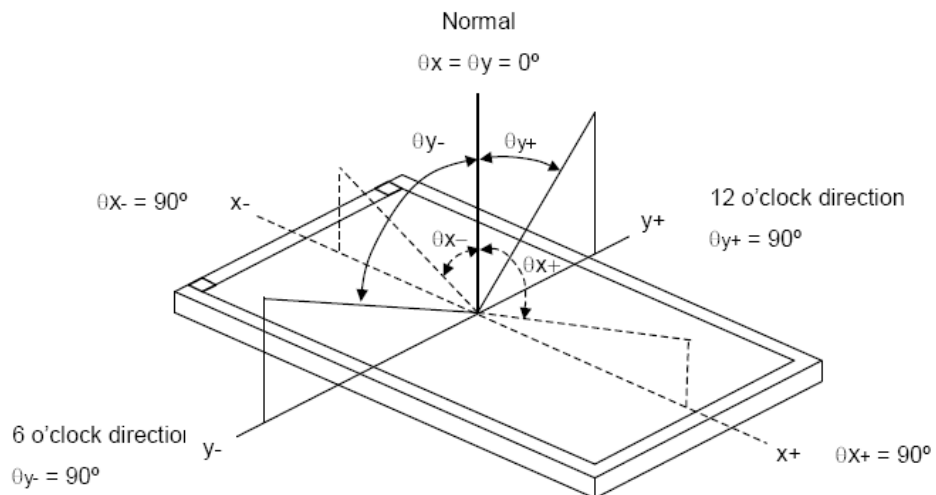
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1 mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



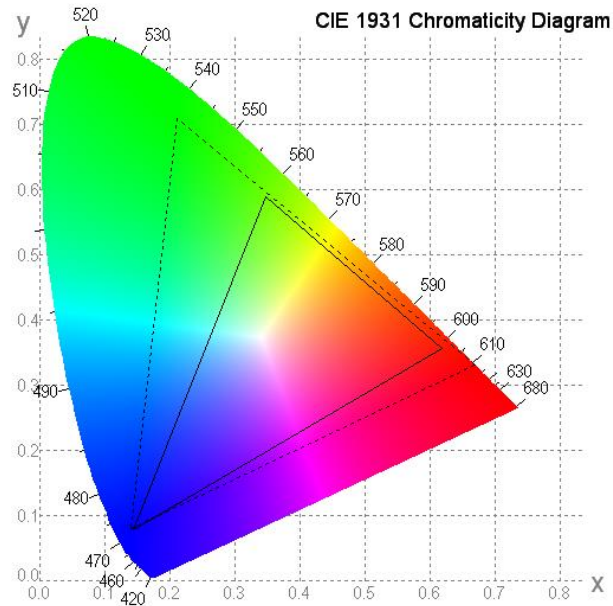
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



6.6. Definition of Surface Luminance, Uniformity and Transmittance

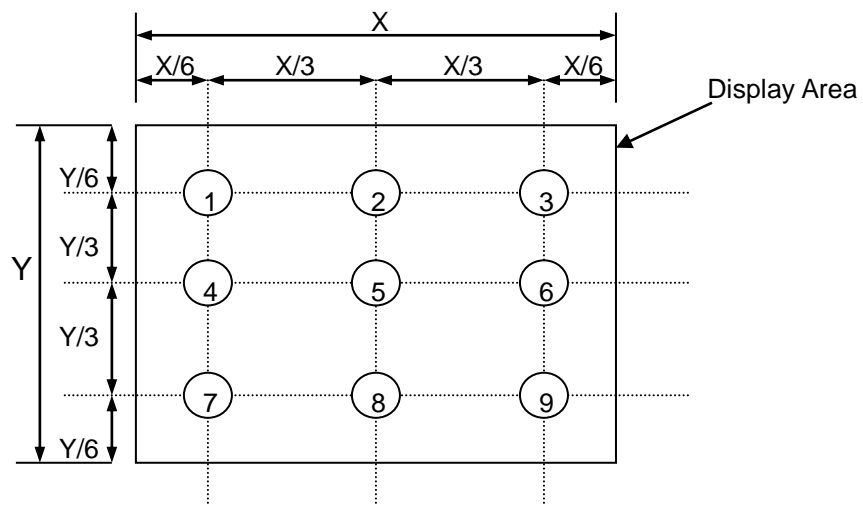
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance: $L_V = \text{average } (L_{P1}:L_{P9})$

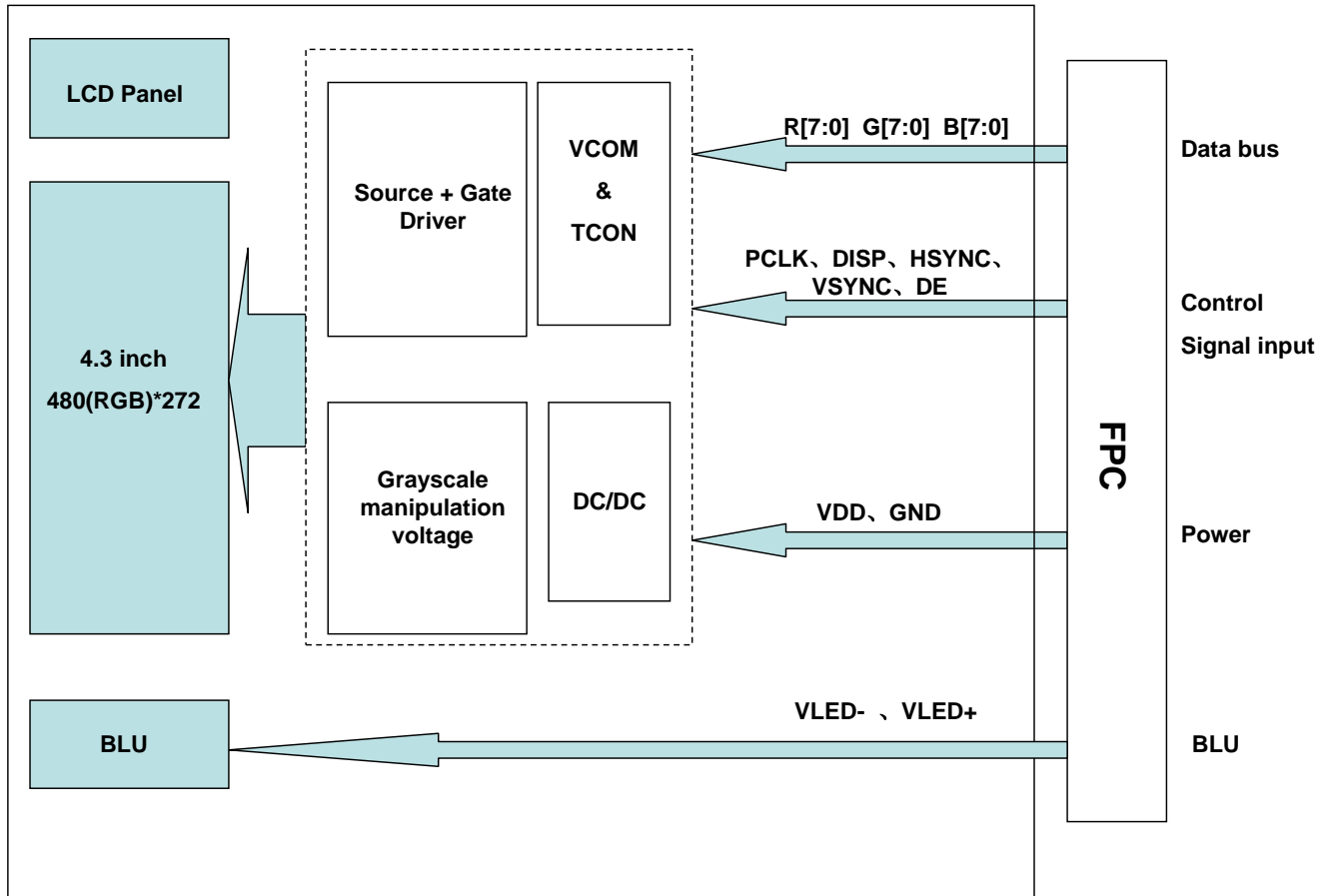
6.6.2. Uniformity = $\text{Minimal } (L_{P1}:L_{P9}) / \text{Maximal } (L_{P1}:L_{P9}) * 100\%$

6.6.3. Transmittance = $L_V \text{ on LCD} / L_V \text{ on Backlight} * 100\%$

Note : Measuring machine: BM-7



7. Block Diagram and Power Supply



8. Interface Pins Definition

No.	Symbol	Function	Remark
1	VLED-	Backlight Cathode	
2	VLED+	Backlight Anode	
3	GND	Ground	
4	VDD	Power source	
5	R0	Red data signal	
6	R1	Red data signal	
7	R2	Red data signal	
8	R3	Red data signal	
9	R4	Red data signal	
10	R5	Red data signal	
11	R6	Red data signal	
12	R7	Red data signal	
13	G0	Green data signal	
14	G1	Green data signal	
15	G2	Green data signal	
16	G3	Green data signal	
17	G4	Green data signal	
18	G5	Green data signal	
19	G6	Green data signal	
20	G7	Green data signal	
21	B0	Blue data signal	
22	B1	Blue data signal	
23	B2	Blue data signal	
24	B3	Blue data signal	
25	B4	Blue data signal	
26	B5	Blue data signal	
27	B6	Blue data signal	
28	B7	Blue data signal	
29	GND	Ground	
30	PCLK	Clock signal to sample each data	
31	DISP	Display on/off signal. DISP="H" Display on; DISP="L" Display off	
32	HSYNC	Horizontal synchronizing signal	
33	VSYNC	Vertical synchronizing signal	
34	DE	Input data enable control.	
35	NC	No connection	
36	GND	Ground	
37	NC(XR)	No connection	
38	NC(YD)	No connection	
39	NC(XL)	No connection	
40	NC(YU)	No connection	

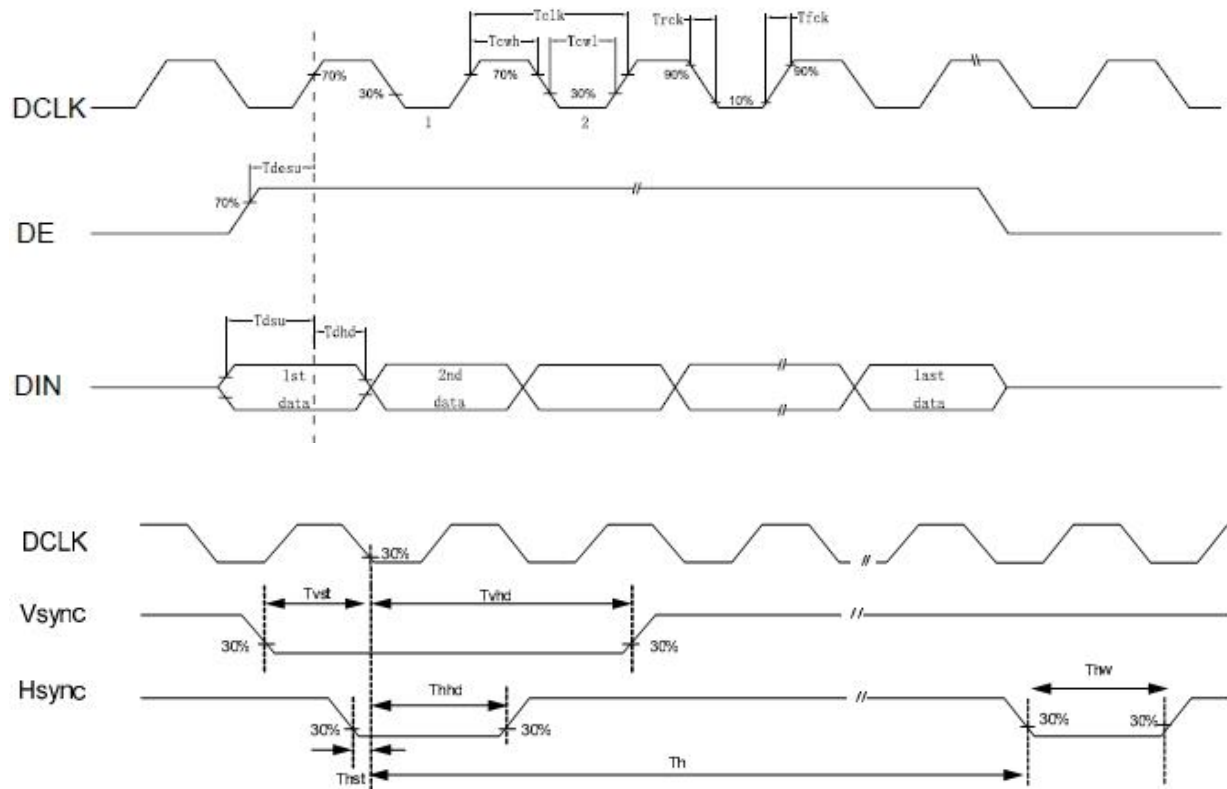
9. AC Characteristics

VDDIO=1.8V, VDD = 3.3V, AVDD = 6V, AGND = 0V, T_a = -20°C to 80°C

Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
CLK pulse duty	T _{cd}	40	50	60	%	
Hsync width	T _{hw}	1.0	-	-	DCLK	
Hsync period	T _h	55	60	65	us	
Vsync setup time	T _{vst}	12	-	-	ns	
Vsync hold time	T _{vhd}	12	-	-	ns	
Hsync setup time	T _{hst}	12	-	-	ns	
Hsync hold time	T _{hhd}	12	-	-	ns	
Data set-up time	T _{dsu}	12	-	-	ns	
Data hold time	T _{dhd}	12	-	-	ns	
DE set-up time	T _{desu}	12	-	-	ns	
DE hold time	T _{d ehd}	12	-	-	ns	
SD output stable time	T _{st}	-	10	12	us	
GD output rise and fall time	T _{gst}	-	500	1000	ns	

10. AC Timing Diagram

10.1.1 Clock and Data Input Timing Diagram



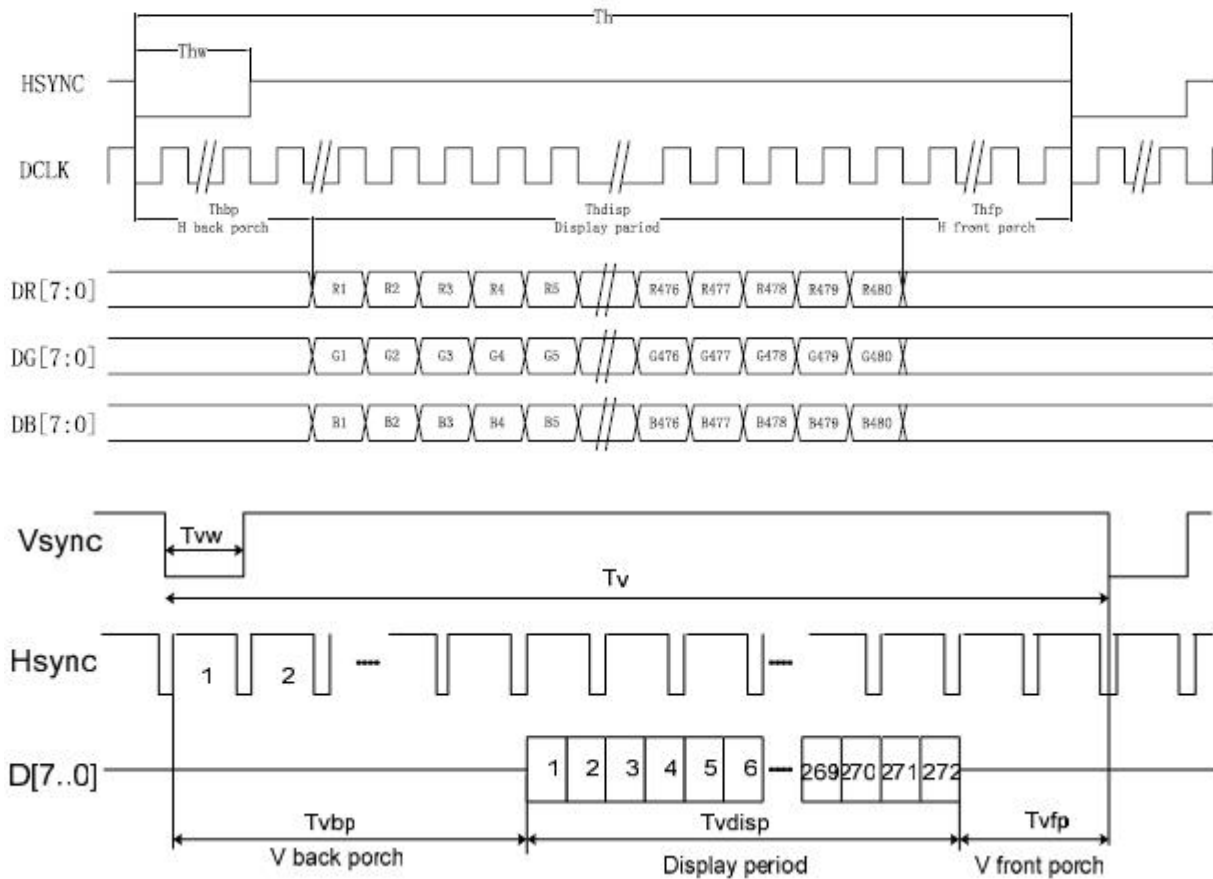
11. INPUT DATA FORMAT

11.1 Parallel RGB Data Format

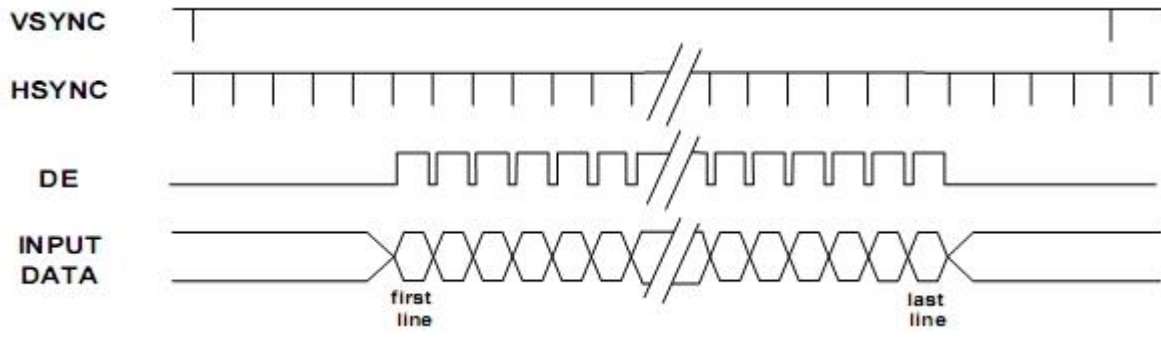
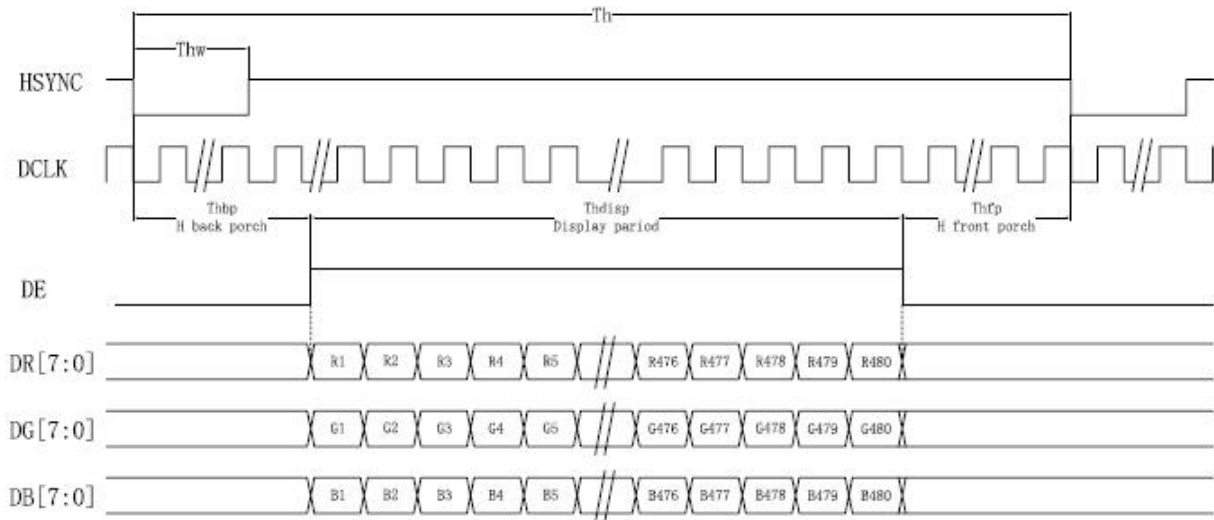
11.1.1 Parallel RGB Input Timing Table

Item		System	Min.	Typ.	Max.	Unit	
DCLK Frequency		Fclk	-	10.7	-	MHz	
Hsync	Period Time	Th	-	531	-	DCLK	
	Display Period	Thdisp	-	480	-	DCLK	
	Back Porch	Thbp	-	43	-	DCLK	By H_BLANKING setting
	Front Porch	Thfp	-	8	-	DCLK	
	Pulse Width	Thw	-	2	-	DCLK	
Vsync	Period Time	Tv	-	288	-	H	
	Display Period	Tvdisp	-	272	-	H	
	Back Porch	Tvbp	-	12	-	H	By V_BLANKING setting
	Front Porch	Tvfp	-	4	-	H	
	Pulse Width	Tvw	-	10	-	H	

11.1.2 SYNC Mode Timing Diagram



11.1.3 SYNC-DE Mode Timing Diagram



12. Precautions and Warranty

14.1 Safety

14.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

14.1..2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

14.2 Handling

14.2.1 Reverse and use within ratings in order to keep performance and prevent damage.

14.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

14.3 Storage

14.3.1 Do not store the LCD module beyond the specified temperature ranges.

14.4 Metal Pin (Apply to Products with Metal Pins)

14.4.1 Pins of LCD and Backlight

14.4.1.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering

14.4.1.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

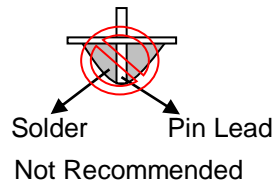
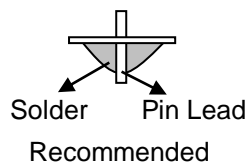
Maximum Solder Temperature: 370°C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20°C

Typical Soldering Time: ≤3s

14.4.1.3 Solder Wetting



14.4.2 Pins of EL

14.4.2.1 Solder tip can touch and press on the tip of EL leads during soldering.

14.4.2.2 No Solder Paste on the soldering pad on the motherboard is recommended.

14.4.2.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290°C

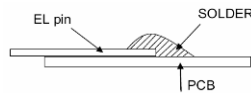
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

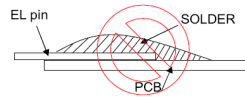
14.4.2.4 No horizontal press on the EL leads during soldering.

14.4.2.5 180° bend EL leads three times is not allowed.

14.4.2.6 Solder Wetting

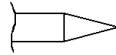


Recommended

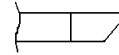


Not Recommended

14.4.2.7 The type of the solder iron:

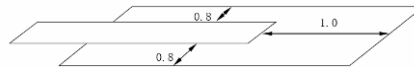


Recommended



Not Recommended

14.4.2.8 Solder Pad



14.5 Operation

- 14.5.1 Do not drive LCD with DC voltage
- 14.5.2 Response time will increase below lower temperature
- 14.5.3 Display may change color with different temperature
- 14.5.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

14.6 Static Electricity

- 14.6.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 14.6.2 The normal static prevention measures should be observed for work clothes and benches.
- 14.6.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

14.7 Limited Warranty

- 14.7.1 Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 14.7.2 If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used

13. Outline Drawing

